

TECHNICAL DATA

Designers' Data Sheet

PROPORTIONALLY CONTROLLED HEATER FOR TO-8 PACKAGES

The DN-530 is a subminiature proportionally controlled heater whose temperature can be programmed with a single external resistor. This device is used for regulating the temperature of sensitive electronic components such as microwave oscillators that are housed in TO-8 packages. The DN-530 can supply up to 9 watts of power from an unregulated 15 volt supply.

FEATURES

- ALUMINUM BASE FOR GOOD THERMAL CONDUCTION
- REGULATION TEMPERATURE FROM 5° C ABOVE AMBIENT TO 100° C
- 10 TO 15 VOLT OPERATION
- ELECTRICALLY ISOLATED FROM THE PACKAGE

MAXIMUM RATINGS

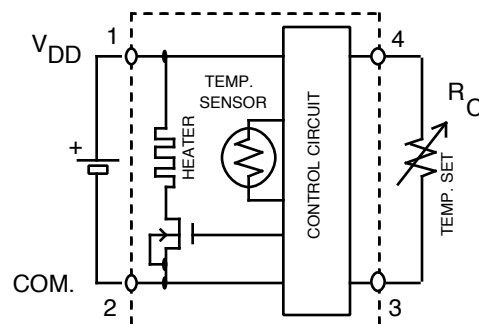
| Rating | Symbol | Value | Unit |
|-----------------------|-----------|-------------|-------|
| Supply Voltage | V_{DD} | 18 | Vdc |
| Power Dissipation | P_D | 16 | Watts |
| Operating Temperature | T_{max} | 120 | °C |
| Storage Temperature | T_{min} | -65 to +150 | °C |

OPERATING CHARACTERISTICS

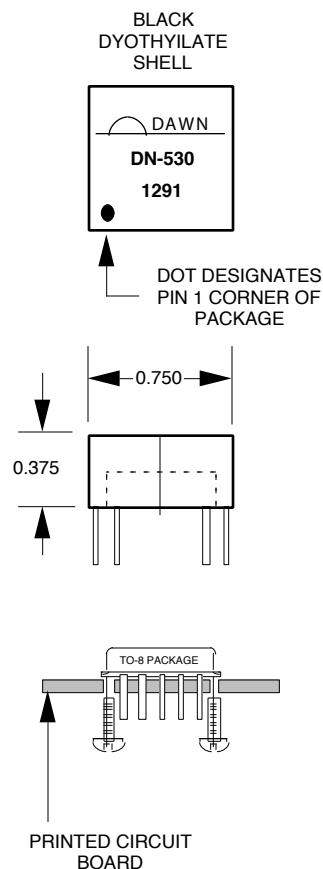
| Characteristic | Symbol | Min | Max | Unit |
|--|--------------|-----------|-----|------------------|
| Supply Voltage (Pin 1 to Pin 4) | V_{DD} | +10 | +16 | Vdc |
| Steady State Supply Current @ $V_{DD} = +15$ Vdc | I_S | 5.0 | 700 | mA _{dc} |
| Temperature Variation over Operating Voltage | ΔT_V | | 2 | °C |
| Temperature Variation with Load | ΔT_L | | 6 | °C |
| Control Temperature Range | T_C | $T_A + 5$ | 100 | °C |
| Control Resistor Value Pin 2 to Pin 3 (See Figure 1) | R_C | 0 | | Ohm |
| Maximum Control Temperature when $R_C = 0$ Ohms | T_{max} | | 120 | °C |
| Turn on power at start-up @ $V_{DD} = +15$ Volts | P_D | 9.0 | | Watts |

DN-530

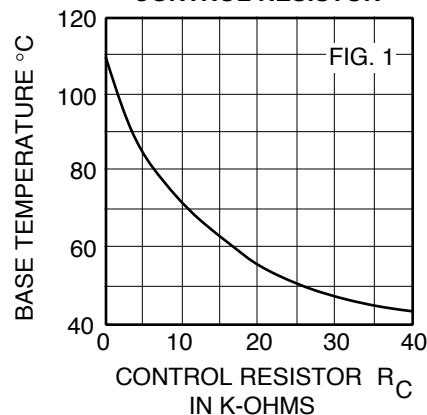
HEATER BLOCK DIAGRAM



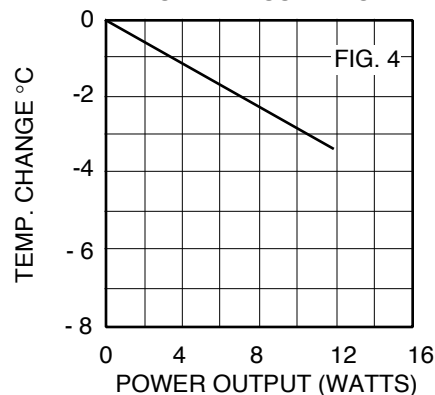
PACKAGE OUTLINE



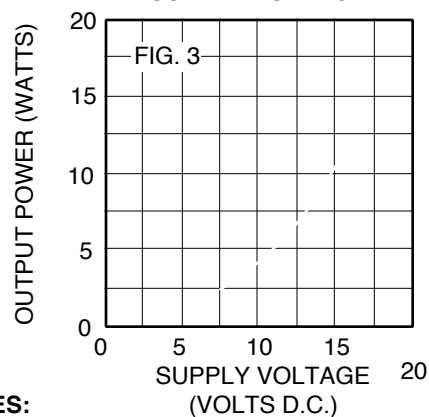
**TYPICAL
CASE TEMPERATURE
VS
CONTROL RESISTOR**



**TYPICAL BASE TEMPERATURE
CHANGE WITH
POWER DISSIPATION**



**MAX. THERMAL POWER
AVAILABLE
VS.
SUPPLY VOLTAGE**



NOTES:

1. Do not reverse the voltage polarity on the input power leads. This can cause permanent damage to the device.
2. Optimum heat transfer between the DN-530 and the TO-8 package being heated occurs when thermal compound, such as Dow Corning 340, is applied to the mounting surface of the heater.

PACKAGE DIMENSIONS

